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APPLICATIONS







OPTICAL MICRO FLYOVER™ ASSEMBLY

FEATURES

- Standard Temperature range from 0 °C to +70 °C
- Interchangeable with FireFly[™] copper using the same micro connector system
- x4 & x12
- 14 Gbps, 16 Gbps, 25 Gbps and 28 Gbps
- Proven 850 nm VCSEL array
- Cost-effective multi-mode fiber
- Integral heat sink
- Angled fiber exit from the housing to minimize keep-out zone on the board
- Bend Radius: 7.5 mm
- Supports data center and HPC protocols, including: Ethernet, InfiniBand™, Fibre Channel, PCIe® (See firefly@samtec.com)
- Evaluation & development boards available

SPECIFICATIONS

For complete specifications see www.samtec.com?ECUO

> Class 1 LASER PRODUCT per IEC 60825-1 Ed. 2 (2007

ELECTRICAL SOLUTIONS

- Performance to 28 Gbps
- · Easily upgrade to optical with same connector system See ECUE Series.

MTP® is a registered trademark of US Conec Ltd.

Patents: 8588562, 8588561 Additional patents pending

Note:

All FireFly™ designs, specifications and components are preliminary and subject to change without notice.

Choice of cable construction Mates with: and passive UEC5, UCC8, OPA end options **INSERTION TOOL** • CAT-IN-ECUO-02 **APPLICATION** Multiple standard and custom heat sinks Rugged latching system IN DEVELOPMENT Rugged two-piece connector system Other fiber types with positive latching Contact firefly@samtec.com

-T12 = x12 Tx **Simplex Optical**

WIDTH

ECUO

-R12 = x12 Rx Simplex Optical

-Y12 = x12**Duplex Optical**

-B04 = x4 Duplex Optical

(Y Configuration)

-14 = 14 Gbps per lane

RATE

-16 = 16 Gbps per lane (x12 only)

25 = 25 Gbps per lane (x4 only)

-28 = 28 Gbps per lane

"XXX" = Overall

CABLE

LENGTH

Length in Centimeters (011 cm to 999 cm) (Minimum length

will depend on fiber type and End 2 option specified.)

= Flat **-2** = Pin-fin -14 & -16 only)

-3 = Flat with 3-Ribbon pass- through

SINK

-4 = PCle® Pin-fin (-14 & -16 only)

> -5 = Pin-fin (-28 only)

-Y12 requires -2(X) options' = OM3 Low

> -01 = MTP® 12F key down, , male

= OM3 Low Bend Radius -02Loose Tube

Bend Radius

Ribbon

-2

(5.76)

(7.40).291

-05 = MT 12F male

-06= MT 12F

1 -1 FLAT HEAT SINK

-3 FLAT PASS-THROUGH HEAT SINK

(with fiber groove for multi-row configuration)

OPTION

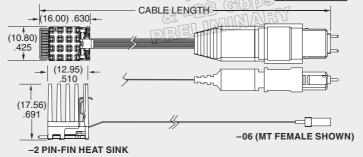
-21*
= MTP 24F key down, , male

-22* MTP® 12F = MTP® 24F key down, key down, female

> -25* = MT 24F male

> > 26* = MT 24F

female



Due to technical progress, all designs, specifications and components are subject to change without notice

WWW.SAMTEC.COM







EXTENDED TEMP OPTICAL MICRO FLY

FEATURES

- Extended temperature range from -40 °C to +85°C versus standard 0 °C to +70 °C (ECUO Series)
- High-speed performance to 10.3125 Gbps per channel
- x12 simplex, x12 duplex or x4 duplex optical transceiver system
- Demonstrated errorfree transmission during applied external vibrations and shock test, to methods specified in MIL-STD-810G
- Integral heat sink provides optimal cooling for thermal operating conditions
- MT & MTP® standard end options (Other options available: MT38999, MTP®, MXC® ARINC 801 and ARIB)
- Micro rugged board level connector system with positive latching, weld tabs and loading guides for secure connection
- Cost-effective OM3 multi-mode fiber
- An angled fiber exit from the housing to minimize keep-out zone on the board

SPECIFICATIONS

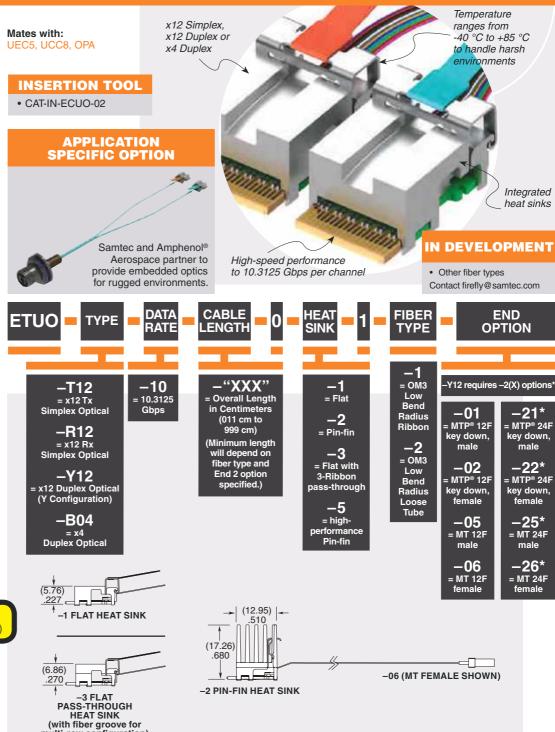
For complete specifications see www.samtec.com?ETUO

> **Class 1 LASER PRODUCT** per IEC 60825-1 Ed. 2 (2007)

Patents: 8588562, 8588561 Additional patents pending

MTP® & MXC® is a registered trademark of US Conec Ltd.

PCI-SIG®, PCI Express® and the PCIe® design marks are registered trademarks and/or service marks of PCI-SIG.



Due to technical progress, all designs, specifications and components are subject to change without notice

multi-row configuration)







PCIe®-OVER-FIBER OPTICAL FLYOV

FEATURES

PCIe® Gen 3 x4, scalable to x8 and x16 widths

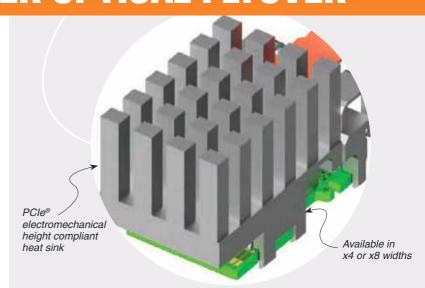
- Duplex auxiliary signals allow both transparent and non-transparent bridging
- High-performance signal quality with BER better than 1E-12
- Enables links up to 100 m
- · Allows nontraditional FPGA/ASIC end points
- · Additional heat sink, fiber type and end options available
- Standard temperature range 0 °C to +70 °C; Extended temperature version available (PTUO)
- PCle® Gen 4 version in development

SPECIFICATIONS

For complete specifications see www.samtec.com?PCUO

Mates with:

UEC5, UCC8, OPA



PCUO SPEED

> **-G3** = Gen 3 Speed

WIDTH

-04x4 PCle® Gen 3

-08 = x8 PCle® Gen 3

CABLE LENGTH

·"XXX" = Overall Length in Centimeters (10 cm Min)

Class 1 LASER PRODUCT per IEC 60825-1 Ed. 2 (2007

OTHER SOLUTIONS



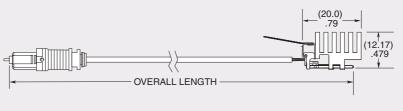
transparent and non-transparent bridge links

PCI-SIG®, PCI Express® and the PCIe® design marks are registered trademarks and/or service marks of PCI-SIG.

Note:

Some lengths, styles and options are non-standard, non-returnable.



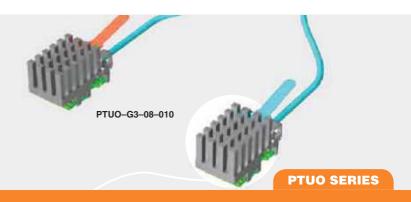


PCUO-G3-04-XXX SHOWN

Due to technical progress, all designs, specifications and components are subject to change without notice







EXTENDED TEMP PCIe®-OVER-FIBER

FEATURES

Extended temperature range from -40 °C to +85 °C and -5 °C to +85 °C

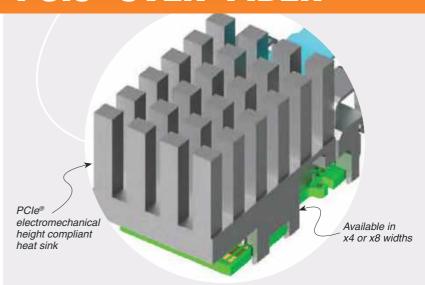
- PCle® Gen 3 x4. scalable to x8 and x16 widths
- Duplex auxiliary signals allow both transparent and non-transparent bridging
- · High-performance signal quality with BER better than 1E-12
- Enables links up to 100 m
- Allows nontraditional FPGA/ASIC end points
- · Additional heat sink, fiber type and end options available
- PCIe® Gen 4 version in development

SPECIFICATIONS

For complete specifications see www.samtec.com?PTUO

Mates with:

UEC5, UCC8, OPA



PTUO SPEED WIDTH

-G3 = x4 PCle® Gen 3 = Gen 3 Speed

CABLE LENGTH

> ·"XXX" = Overall Length in Centimeters (10 cm Min)

Class 1 LASER PRODUCT per IEC 60825-1 Ed. 2 (2007)

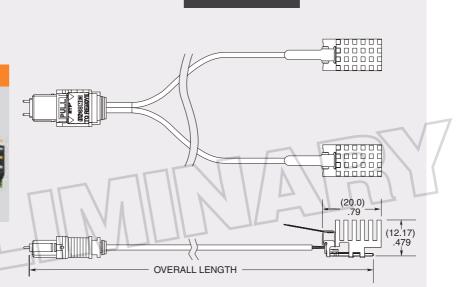
OTHER SOLUTIONS



PCOA is a compatible PCIe® adaptor card supporting transparent and non-transparent bridge links

PCI-SIG®, PCI Express® and the PCIe® design marks are registered trademarks and/or service marks of PCI-SIG.

Some lengths, styles and options are non-standard, non-returnable.



PTUO-G3-08-XXX SHOWN

-04

-08 = x8 PCle® Gen 3

Due to technical progress, all designs, specifications and components are subject to change without notice







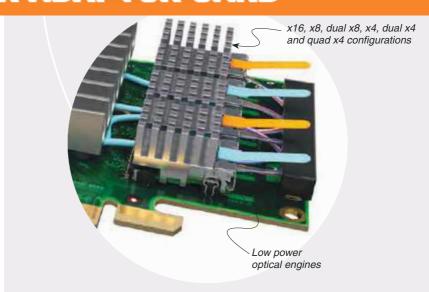
PCIe^oOVER-FIBER ADAPTOR CARD

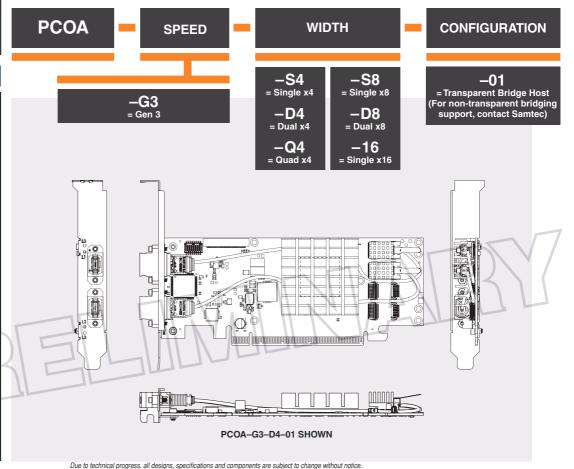
FEATURES

- Uses PCUO FireFly[™] optical cable for clear signal transmissions with increased reach and cost optimization
- Supports PCle® Gen 3
- PCIe® x16 edge card connector
- Scalable configurations for cost optimized performance
- Transparent or nontransparent bridging for system flexibility and multi-processor support
- Reconfigurable host or target operation
- Gen 4 in development
- Ideal for highperformance and applications requiring robust data transmission

SPECIFICATIONS

For complete specifications see www.samtec.com?PCOA





Note: Some sizes, styles and options are non-standard, non-returnable.





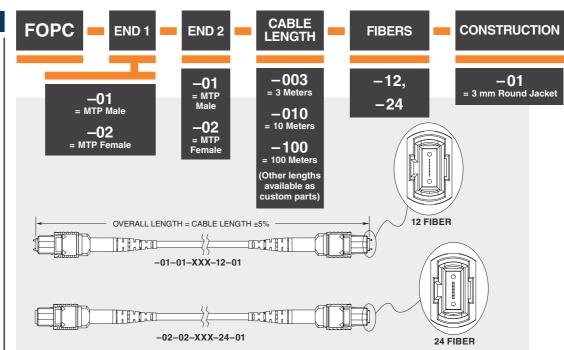
FOPC, OPA SERIES

OPTICAL PATCH CABLE AND ADAPTOR

SPECIFICATIONS

For complete specifications see www.samtec.com?FOPC

Compliant Specifications: TIA-604-5-D (FOCIS 5) TIA-568-C.3 IEC-61754-7-1



Note: Some lengths, styles and options are non-standard, non-returnable.

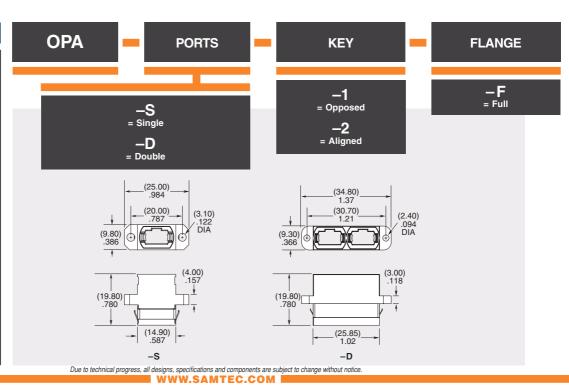
SPECIFICATIONS

For complete specifications see www.samtec.com?OPA

Compliant Specifications: TIA-604-5-D (FOCIS 5) IEC-61754-7 Recommended

Recommended
Panel Thickness:
(1.75 mm) .069"
(The OPA can be installed with any panel thickness but mounting hardware is needed for any thickness that is not (1.75 mm) .069".
Contact the Optics Group at Optics@samtec.com for questions about panel thickness and mounting hardware.) and mounting hardware.)

Note: Some lengths, styles and options are non-standard, non-returnable.







Ultra-flexible

(5.54)

ACTIVE OPTICAL CABLE ASSEMBLIES

FEATURES

Drop in replacement for PCIE® electrical cable

SPECIFICATIONS

For complete specifications see www.samtec.com?PCIEO

Fiber Type: 1 m to 50 m = OM2 Over 50 m = OM3 All Half AOCs = OM3

RECOGNITIONS

For complete scope of recognitions, see www.samtec.com/quality



lightweight fiber Gen 3 rates up to 100 meters ightweight assembly Supports sidebands

DATA CABLE PCIEO OPTIONS RATE LENGTH -11 -4G3 -000.5 = x4 PCle®, GEN 3 = 500 mm = 100 MHz Clock **Full AOC** Frequency (Standard) to With Host -8G3 & Target -100.0 = x8 PCle®, GEN 3 = 100 m -12 Standard lengths = 100 MHz Clock -H8G3 Frequency (No Sidebands) = x4 PCle® with, x8 PCle® form factor, GEN 3 -15 = No Clock Output -4AG3 = x4 PCle® Host to (Standard) x8 PCIe® Target, GEN 3 -16 **-8AG3** No Clock Output (No Sidebands) = x8 PCle® Host to x4 PCle® Target, GEN 3 OVERALL LENGTH = CABLE LENGTH ± 5% (33.94)1.336

Patents: 7329054, 7824112, 7648287, 7766559, 8098993, additional patents pending

Notes: Samtec PCle® over Fiber systems are PCle® compliant; however as with all PCle® based systems, there is a risk of interoperability issues with specific systems. Samtec recommends discussing your system with our Optical Group prior to final design. Please contact pcie@samtec.com.

PCI-SIG®, PCI Express® and the PCIe® design marks are registered trademarks and/or service marks of PCI-SIG.

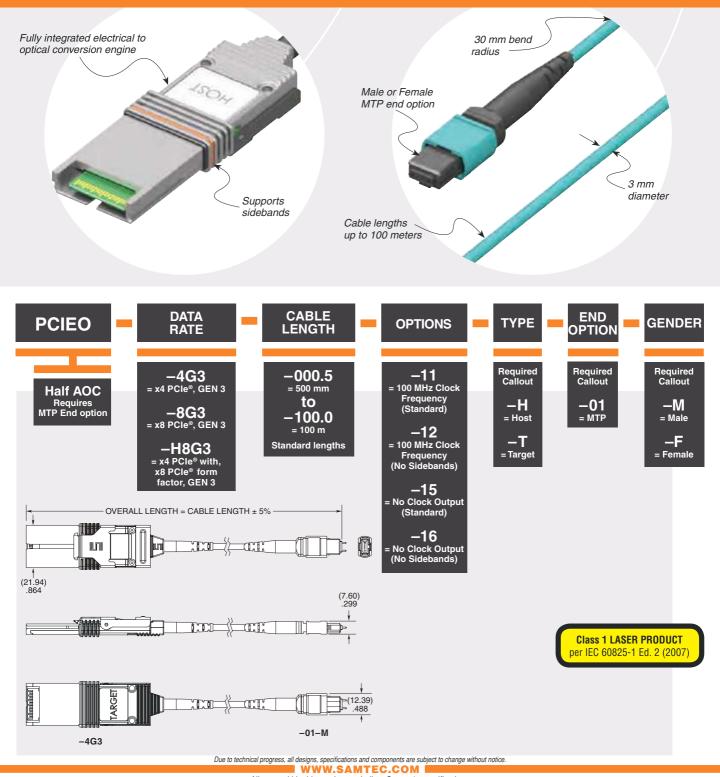
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-8G3 SHOWN

(71.30) 2.807







OPTICAL DEVELOPMENT KITS

TESTING SOLUTIONS

FireFly[™] Test Kit (FIK-FIREFLY-XX)

Rated up to 25 Gbps, this kit allows the designer real-time evaluation of an actively running copper or optical FireFly™ system in their lab, with their inputs, via Samtec's Bulls Eye® system.

14 Gbps FireFly[™] **FMC Development Kit**

(REF-193429-01)

Samtec's 14 Gbps FireFly™ FMC Module is VITA 57.1 compliant and provides up to 140 Gbps full-duplex bandwidth over 10 channels from an FPGA to an industry-standard multi-mode fiber optic cable.

25/28 Gbps FireFly™ **FMC+ Development Kit**

(REF-200772-XXX-XX-01)

Samtec's 25/28 Gbps FireFly™ FMC+ Module is VITA 57.4 compliant and provides up to 400/448 Gbps full-duplex bandwidth over 16 channels from an FPGA to an industry-standard multi-mode fiber optic cable.

For more information go to samtec.com/firefly or samtec.com/kits



ACTIVE & PASSIVE OPTICS



FMC+ HSPC Loopback Card

(REF-194194-01)

This loopback mezzanine card was based on an elongated version of the VITA 57.4 single width mezzanine card, designed for use with the Xilinx® UltraScale™+ VCU118 Development Board and is included in the VCU118 Development Kit available from Xilinx®.

For more information go to samtec.com/kits